



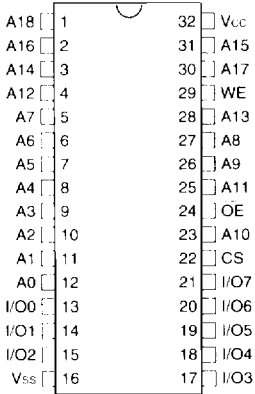
512Kx8 SRAM MODULE

FEATURES

- Access Times 55 to 120nS
- Standard Microcircuit Drawing, 5962-92078
- MIL-STD-883 Compliant Devices Available
- JEDEC Standard 32 pin, Hermetic Ceramic DIP (Package 302)
- Military Temperature Range (-55°C to +125°C)
- Organized as 512K x 8
- 5 Volt Power Supply
- Low Power CMOS
- TTL Compatible Inputs and Outputs
- Battery Back-Up Operation

FIG. 1

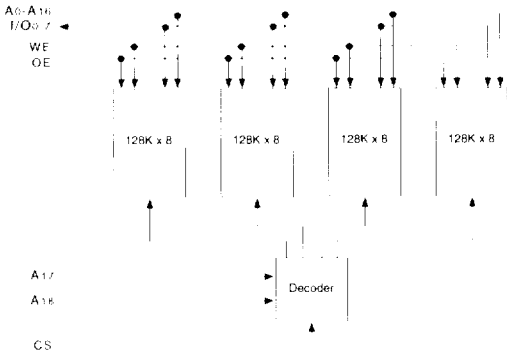
PIN CONFIGURATION TOP VIEW



PIN DESCRIPTION

A0-18	Address Inputs
I/O0-7	Data Input/Output
CS	Chip Select
OE	Output Enable
WE	Write Enable
Vcc	+5.0V Power
Vss	Ground

BLOCK DIAGRAM



4 SRAM MODULES



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Operating Temperature	T _A	-55	+125	°C
Storage Temperature	T _{STG}	-65	+150	°C
Signal Voltage Relative to GND	V _G	-0.5	V _{CC} +0.5	V
Junction Temperature	T _J		150	°C
Supply Voltage	V _{CC}	-0.5	7.0	V

TRUTH TABLE

\overline{CS}	\overline{OE}	\overline{WE}	Mode	Data I/O	Power
H	X	X	Standby	High Z	Standby
L	L	H	Read	Data Out	Active
L	X	L	Write	Data In	Active
L	H	H	Out Disable	High Z	Active

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Max	Unit
Supply Voltage	V _{CC}	4.5	5.5	V
Input High Voltage	V _{IH}	2.2	V _{CC} + 0.3	V
Input Low Voltage	V _{IL}	-0.5	+0.8	V
Operating Temp. (Mil.)	T _A	-55	+125	°C

CAPACITANCE

(T_A = +25°C)

Parameter	Symbol	Condition	Max	Unit
Input capacitance	C _{IN}	V _{IN} = 0V, f = 1.0MHz	40	pF
Output capacitance	C _{OUT}	V _{OUT} = 0V, f = 1.0MHz	40	pF

This parameter is guaranteed by design but not tested.

DC CHARACTERISTICS

(V_{CC} = 5.0V, V_{SS} = 0V, T_A = -55°C to +125°C)

Parameter	Sym	Conditions	-55		-70		-85		-100		-120		Units
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
Input Leakage Current	I _{CI}	V _{CC} = 5.5, V _{IN} = GND to V _{CC}		10		10		10		10		10	µA
Output Leakage Current	I _{LO}	$\overline{CS} = V_{IH}, \overline{OE} = V_{IH}, V_{OUT} = GND \text{ to } V_{CC}$		10		10		10		10		10	µA
Operating Supply Current	I _{CC}	$\overline{CS} = V_{IL}, \overline{OE} = V_{IH}, f = 5\text{MHz}, V_{CC} = 5.5$		130		100		80		70		70	mA
Standby Current	I _{SB}	$\overline{CS} = V_{IH}, \overline{OE} = V_{IH}, f = 5\text{MHz}$		50		5		4		2.5		2.5	mA
Output Low Voltage	V _{OL}	I _{OL} = 2.1mA, V _{CC} = 4.5		0.4		0.4		0.4		0.4		0.4	V
Output High Voltage	V _{OH}	I _{OH} = -1.0mA, V _{CC} = 4.5	2.4		2.4		2.4		2.4		2.4		V

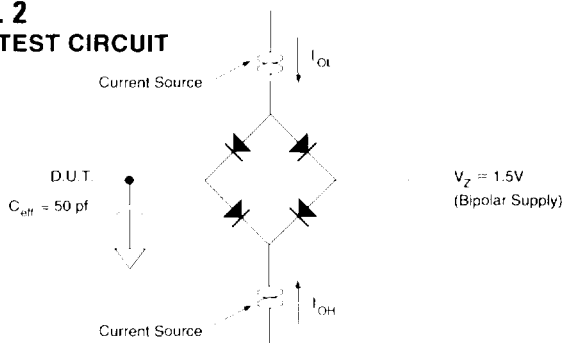
NOTE: DC test conditions: V_{IH} = V_{CC} - 0.3V, V_{IL} = 0.3V

DATA RETENTION CHARACTERISTICS

(T_A = -55°C to +125°C)

Parameter	Symbol	Conditions	-55		-70		-85		-100		-120		Units		
			Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min		Typ	Max
Data Retention Supply Voltage	V _{DR}	$\overline{CS} \geq V_{CC} - 0.2V$	2.0		5.5	2.0		5.5	2.0		5.5	2.0		5.5	V
Data Retention Current	I _{CCDR1}	V _{CC} = 3V		30	3200		30	3000		10	1600		10	1100	µA
	I _{CCDR2}	V _{CC} = 2V		20	2100		20	2000		8	1200		8	800	µA

FIG. 2
AC TEST CIRCUIT



AC TEST CONDITIONS

Parameter	Typ	Unit
Input Pulse Levels	V _{IL} = 0, V _{IH} = 3.0	V
Input Rise and Fall	5	nS
Input and Output Reference Level	1.5	V
Output Timing Reference Level	1.5	V

NOTES:

- V_Z is programmable from -2V to +7V
- I_{OL} & I_{OH} programmable from 0 to 16mA
- Tester Impedance Z_{in} = 75 Ω
- V_Z is typically the midpoint of V_{OH} and V_{OL}
- I_{OL} & I_{OH} are adjusted to simulate a typical resistive load circuit
- ATF tester includes jig capacitance

**AC CHARACTERISTICS**

(VCC = 5.0V, VSS = 0V, TA = -55°C to +125°C)

Parameter	Symbol	-55		-70		-85		-100		-120		Units
		Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
Read Cycle												
Read Cycle Time	t _{RC}	55		70		85		100		120		nS
Address Access Time	t _{AA}		55		70		85		100		120	nS
Output Hold from Address Change	t _{OH}	5		5		15		15		15		nS
Chip Select Access Time	t _{ACS}		55		70		85		100		120	nS
Output Enable to Output Valid	t _{OE}		40		50		55		60		60	nS
Chip Select to Output in Low Z	t _{CLZ}	5		5		10		10		10		nS
Output Enable to Output in Low Z	t _{OLZ}	5		5		5		5		5		nS
Chip Disable to Output in High Z	t _{CHZ}		35		40		45		50		50	nS
Output Disable to Output in High Z	t _{OHZ}		30		40		45		50		50	nS

1. This parameter is guaranteed by design but not tested.

AC CHARACTERISTICS

(VCC = 5.0V, VSS = 0V, TA = -55°C to +125°C)

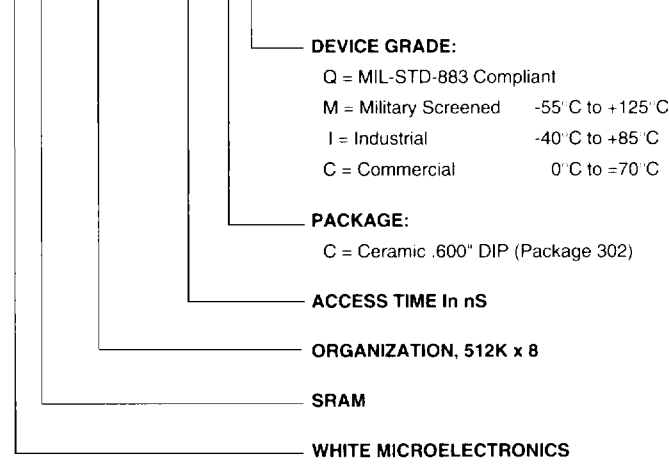
Parameter	Symbol	-55		-70		-85		-100		-120		Units
		Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
Write Cycle												
Write Cycle Time	t _{WC}	55		70		85		100		120		nS
Chip Select to End of Write	t _{CW}	45		65		80		90		110		nS
Address Valid to End of Write	t _{AW}	50		50		75		75		85		nS
Data Valid to End of Write	t _{DW}	30		40		45		50		50		nS
Write Pulse Width	t _{WP}	40		40		65		70		80		nS
Address Setup Time	t _{AS}	0		0		0		0		0		nS
Address Hold Time	t _{AH}	0		0		0		0		0		nS
Output Active from End of Write	t _{OW}	5		10		10		10		10		nS
Write Enable to Output in High Z	t _{WHZ}		30		40		45		50		50	nS
Data Hold Time	t _{DH}	0		0		0		0		0		nS

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ORDERING INFORMATION

W S 512K 8 - XXX C X



4 SRAM MODULES

Device Type	Speed	Package	SMD Number
512K x 8 SRAM	120nS	32 pin DIP	5962-92078 01HXX
512K x 8 SRAM	100nS	32 pin DIP	5962-92078 02HXX
512K x 8 SRAM	85nS	32 pin DIP	5962-92078 03HXX
512K x 8 SRAM	70nS	32 pin DIP	5962-92078 04HXX
512K x 8 SRAM	55nS	32 pin DIP	5962-92078 05HXX